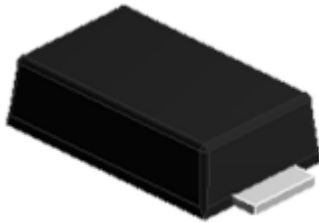


**Surface Mount Glass Passivated Fast Recovery Rectifier**
**SMAF(eSGB)**

**Features**

- ROHS compliant
- Glass passivated chip
- High forward surge capability
- Meet MSL level 1, per J-STD-020  
LF maximum peak of 250 °C
- Solder dip 260 °C / 40S
- Component in accordance to ROHS 2002/95/EC and WEEE 2002/96/WC
- UL recognition, file number E342874


**Primary characteristics**

$I_{F(AV)}$	2A
$V_{RRM}$	50V to 1000V
$I_{FSM}$	60A
$I_{RM}$	5 $\mu$ A
$V_{FM}$ at $I_F=2A$	1.3V
$T_J$ max.	150 °C

**Applications**

Ideal for ac-to-dc bridge full wave rectification such as SMPS, home appliances, office equipment, industrial automation applications

**Mechanical data**

- SMAF(eSGB)
- Epoxy meets UL 94 V-0 flammability rating
- Terminals: Tin plated leads.
- Polarity: As marked.
- Mounting Torque: 10cm $\cdot$ kg(8.8 inches $\cdot$ lbs)max.
- Recommended Torque: 5.7 cm $\cdot$ kg(5 inches $\cdot$ lbs)

**Maximum rating (Ta=25°C unless otherwise noted)**

Parameter	Sym	SMAF(eSGB)							Unit
		L2F1	L2F2	L2F3	L2F4	L2F5	L2F6	L2F7	
Max. repetitive peak reverse voltage	$V_{RRM}$	50	100	200	400	600	800	1000	V
Max. RMS reverse voltage	$V_{RMS}$	35	70	140	280	420	560	700	V
Max. DC blocking voltage	$V_{DC}$	50	100	200	400	600	800	1000	V
Max. average forward current	$I_{F(AV)}$	2							A
Non-repetitive peak forward surge current 8.3ms single half-sine-wave	$I_{FSM}$	60							A
Max. instantaneous forward voltage drop per diode	$V_{FM}$	1.3 (2A)							V
Max. instantaneous reverse current at rated DC blocking voltage	$I_{RM}$	5							$\mu$ A
		50							
Operating junction temperature	$T_J$	-55 ~ +150							°C
Storage temperature	$T_{STG}$	-55 ~ +150							°C
Maximum reverse recovery time	$t_{rr}$	150			250		500		nS
Typical thermal resistance (Note 1)	$R_{J-M}$	12							°C/W
Typical junction capacitance (Note 2)	$C_J$	11							pF

**Notes:**

- 1 The thermal resistance from junction to mount, mounted on P.C.B with 8x8mm copper pads, 2 OZ, FR4 PCB
2. Measured at 1 MHz and Applied Reverse Voltage of 4.0 V D.C



Surface Mount Glass Passivated Fast Recovery Rectifier

Ordering information (Example)

PREFERRED	UNIT WEIGHT (g)	PREFERRED PACKAGE CODE	BASE QUANTITY	DELIVERY MODE
L2F7				

Typical characteristics

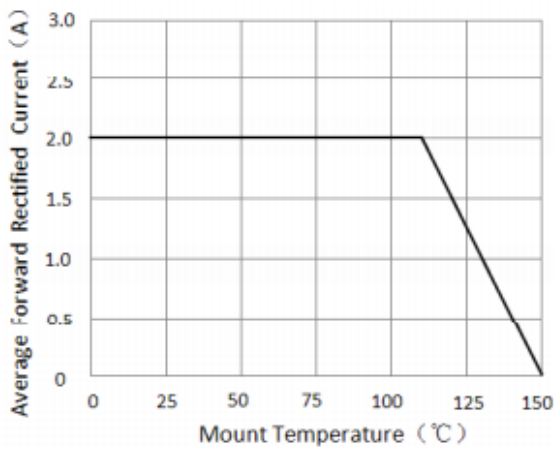


Figure 1. Forward Current Derating Curve

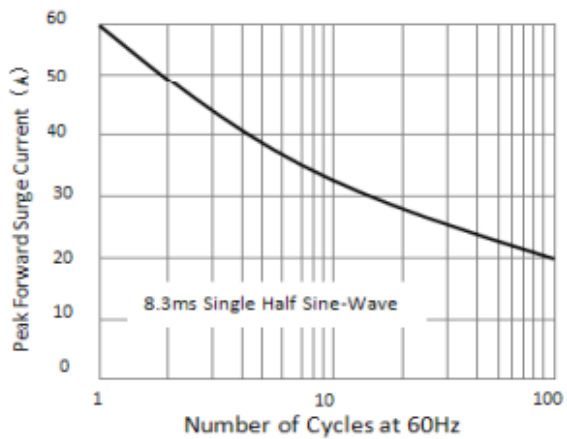


Figure 2. Maximum Non-Repetitive Peak Forward Surge Current

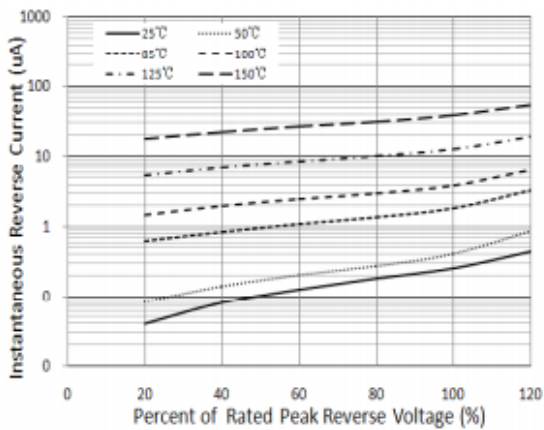


Figure 3. Typical Reverse Characteristics

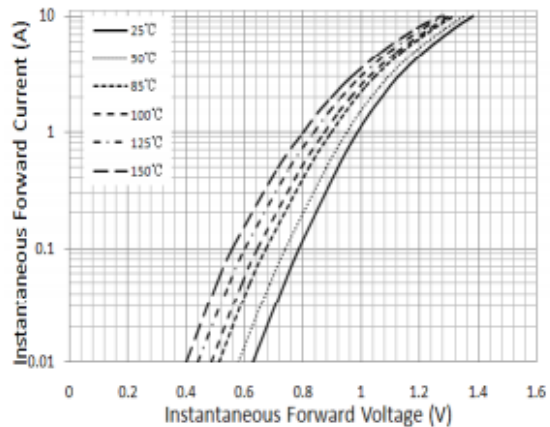


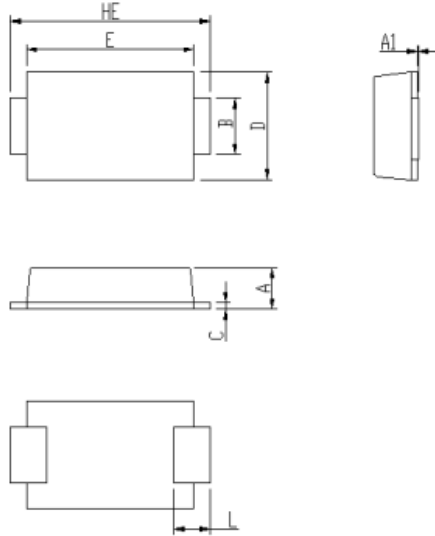
Figure 4. Typical Instantaneous Forward Characteristics



Surface Mount Glass Passivated Fast Recovery Rectifier

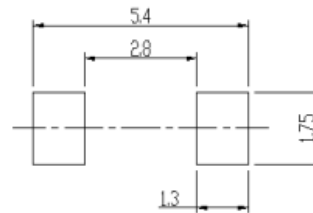
Package outline dimensions

in inches (millimeters)



DIM	Unit: mm		Unit: inch	
	MIN	MAX	MIN	MAX
A	0.92	1.08	0.036	0.043
A1	0	0.1	0.000	0.004
B	1.25	1.45	0.049	0.057
C	0.1	0.25	0.004	0.010
D	2.6	2.8	0.102	0.110
E	4.1	4.3	0.161	0.169
L	0.7	1.1	0.028	0.043
HE	4.8	5.2	0.189	0.205

Soldering footprint



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